

ABSTRACT OF THE DISCLOSURE

An upper area over an element substrate is sealed by a sealing substrate to which a desiccant is fixed on an internal 5 surface of the sealing substrate. A substance prepared by dispersing moisture absorbent grains into an adhesive made of resin is used as the desiccant. Further, the size of the moisture absorbent grains is defined to be equal to or smaller than 10 μ m. In this manner, the desiccant can be prevented from 10 cracking due to temperature variations.